

LISTING OF CLAIMS:

This Listing of Claims will replace all prior versions, and listings, of claims in the application.

Please amend claim 1 as follows:

1. (Currently Amended) A pressure-sensitive adhesive sheet comprising a base material and a pressure-sensitive adhesive layer, having formed therein a plurality of through holes passing through from one surface to the other surface thereof, and being liable to be subjected to a pressure of not less than 1 Pa, the pressure-sensitive adhesive sheet characterized in that:

said through holes have a diameter in said base material and said pressure-sensitive adhesive layer in a range of ~~0.1 to 300~~ 0.5 to 150 μm , and a hole density in a range of 30 to 50,000 per 100 cm^2 ; and

said pressure-sensitive adhesive layer has a storage modulus at 70°C of not less than 9×10^3 Pa, and a loss tangent at 70°C of not more than 0.55.

2. (Previously Presented) The pressure sensitive adhesive sheet according to claim 1, characterized in that said through holes are formed by laser processing.